



N- and P-Channel 30 V (D-S) MOSFET

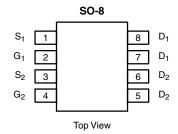
PRODUCT SUMMARY						
	V _{DS} (V)	$R_{DS(on)}(\Omega)$	I _D (A)			
N-Channel	30	0.053 at V _{GS} = 10 V	4.9			
N-Channer		0.075 at V _{GS} = 4.5 V	4.1			
P-Channel	- 30	0.080 at V _{GS} = - 10 V	- 3.9			
r-Ghaillei		0.135 at V _{GS} = - 4.5 V	- 3.0			

FEATURES

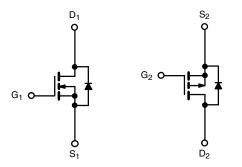
- Halogen-free According to IEC 61249-2-21 **Available**
- TrenchFET® Power MOSFETs
- 100 % R_a Tested
- Compliant to RoHS Directive 2002/95/EC



COMPLIANT HALOGEN FREE



Ordering Information: Si4532ADY-T1-E3 (Lead (Pb-free) Si4532ADY-T1-GE3 (Lead (Pb-free and Halogen-free)



N-Channel MOSFET

P-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS (T _A = 25 °C, unless otherwise noted)							
		Symbol	N-Channel		P-Channel		
Parameter	10 s		Steady State	10 s	Steady State	Unit	
Drain-Source Voltage		V_{DS}	30		- 30		V
Gate-Source Voltage		V_{GS}	± 20		± 20		
Continuous Proin Current /T 150 °C\a	T _A = 25 °C	I -	4.9	3.7	- 3.9	- 3.0	
Continuous Drain Current (T _J = 150 °C) ^a	T _A = 70 °C		3.9	2.9	- 3.1	- 2.4	
Pulsed Drain Current		I _{DM}		Α			
Continuous Source Current (Diode Conduction) ^a		I _S	1.7	0.94	- 1.7	- 1.0	
Mariana Barra Birata di ad	T _A = 25 °C	P _D	2	1.13	2	1.2	W
Maximum Power Dissipation ^a	T _A = 70 °C		1.3	0.73	1.3	0.76	
Operating Junction and Storage Temperature	T _J , T _{stg}			°C			

THERMAL RESISTANCE RATINGS								
		N-Channel		P-Channel				
Parameter	Symbol	Тур.	Max.	Тур.	Max.	Unit		
Maximum Junction-to-Ambient ^a	t ≤ 10 s	- R _{thJA}	55	62.5	54	62.5		
Maximum Junction-to-Ambient [∞]	Steady State		90	110	87	105	°C/W	
Maximum Junction-to-Foot (Drain)	Steady State	R_{thJF}	40	50	34	45		

a. Surface mounted on 1" x 1" FR4 board.

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit		
Static		1200 0000000000000000000000000000000000			7			
	.,,	$V_{DS} = V_{GS}, I_D = 250 \mu A$	N-Ch	1				
Gate Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = - 250 μA P-Ch		- 1			V	
	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$	N-Ch			± 100	nA	
Gate-Body Leakage		$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$	P-Ch			± 100		
		V _{DS} = 30 V, V _{GS} = 0 V	N-Ch			1		
7 0		V _{DS} = - 30 V, V _{GS} = 0 V P-Ch				- 1		
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 30 V, V _{GS} = 0 V, T _J = 55 °C	N-Ch			5	μΑ	
		$V_{DS} = -30 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 ^{\circ}\text{C}$	P-Ch			- 5		
		$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	N-Ch	20			А	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \le -5 \text{ V}, V_{GS} = -10 \text{ V}$	P-Ch	- 20				
		V _{GS} = 10 V, I _D = 4.9 A	N-Ch		0.044	0.053		
		V _{GS} = - 10 V, I _D = - 3.9 A	P-Ch		0.062	0.080		
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = 4.5 V, I _D = 4.1 A	N-Ch		0.062	0.075	Ω	
		V _{GS} = - 4.5 V, I _D = - 3 A	P-Ch		0.105	0.135		
	9 _{fs}	V _{DS} = 15 V, I _D = 4.9 A	N-Ch		11			
Forward Transconductance ^a		V _{DS} = - 15 V, I _D = - 2.5 A	P-Ch		5		S	
	.,	I _S = 1.7 A, V _{GS} = 0 V	N-Ch		0.80	1.2	.,	
Diode Forward Voltage ^a	V_{SD}	I _S = - 1.7 A, V _{GS} = 0 V	P-Ch		- 0.82	- 1.2	V	
Dynamic ^b								
Total Gate Charge	Q_{g}	N.O.	N-Ch		8	16		
Total date onlinge	€g	N-Channel $V_{DS} = 10 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 4.9 \text{ A}$	P-Ch		10	20		
Gate-Source Charge	Q _{qs}	V _{DS} = 10 V, V _{GS} = 10 V, I _D = 4.5 N	N-Ch		1.4		nC	
<u> </u>	ys	P-Channel	P-Ch		2			
Gate-Drain Charge	Q_{gd}	$V_{DS} = -4 \text{ V}, V_{GS} = -10 \text{ V}, I_{D} = -3.9 \text{ A}$	N-Ch P-Ch		1.2 1.9			
			N-Ch	0.4	1.6	3.2		
Gate Resistancee	R_g	f = 1 MHz	P-Ch	1.5	6.2	12	Ω	
Turn On Balan Time			N-Ch		12	20		
Turn-On Delay Time	t _{d(on)}	N-Channel	P-Ch		8	15		
Rise Time	t _r	$V_{DD} = 10 \text{ V}, R_L = 10 \Omega$ $I_D \cong 1 \text{ A}, V_{GEN} = 10 \text{ V}, R_q = 6 \Omega$	N-Ch		10	20		
THISC THING	*1	$iD = i \Delta$, $vGEN - i O v$, $iig = 0.52$	P-Ch		9	18		
Turn-Off Delay Time	t _{d(off)}	P-Channel	N-Ch		23	45	ns	
	t _f	$V_{DD} = -10 \text{ V}, R_L = 10 \Omega$	P-Ch		21 8	40 15		
Fall Time		$I_D \cong -1 \text{ A}, V_{GEN} = -10 \text{ V}, R_g = 6 \Omega$	N-Ch P-Ch		10	20		
		I _F = 1.7 A, dI/dt = 100 A/μs	N-Ch		25	40	1	
Source-Drain Reverse Recovery Time	t _{rr}	$I_F = -1.7 \text{ A}, \text{ dl/dt} = 100 \text{ A/}\mu\text{s}$ P-C					1	

Notes:

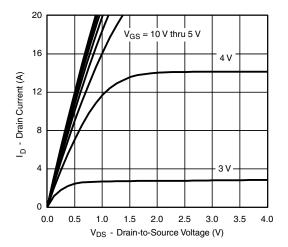
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

a. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %.

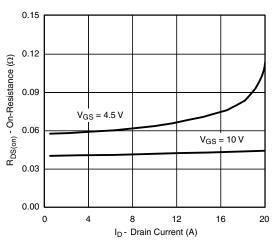
b. Guaranteed by design, not subject to production testing.



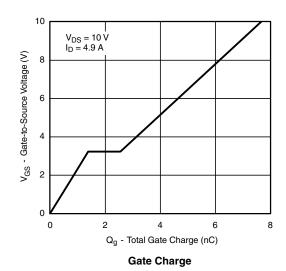
N-CHANNEL TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

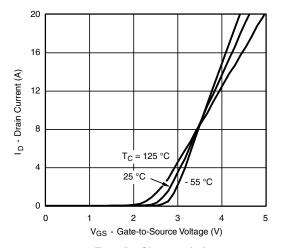


Output Characteristics

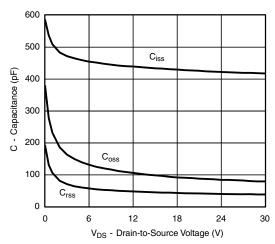


On-Resistance vs. Drain Current

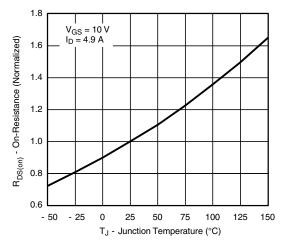




Transfer Characteristics



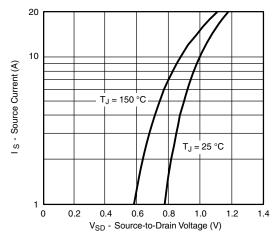
Capacitance



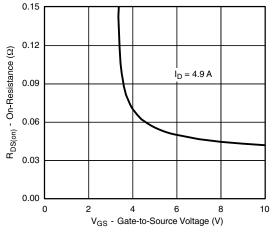
On-Resistance vs. Junction Temperature

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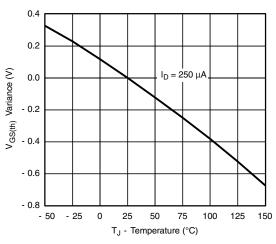
N-CHANNEL TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



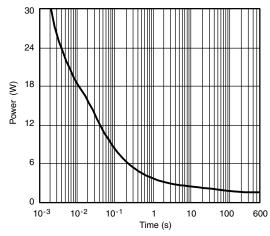
Source-Drain Diode Forward Voltage



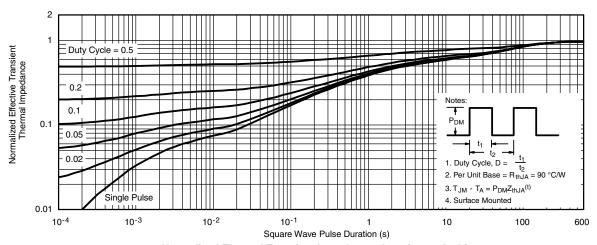
On-Resistance vs. Gate-to-Source Voltage



Threshold Voltage



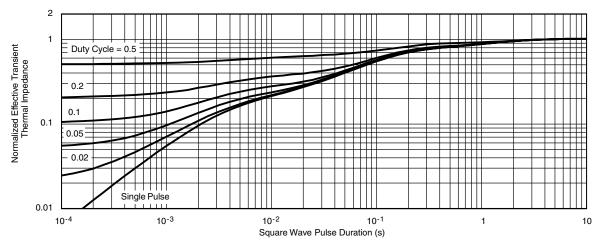
Single Pulse Power



Normalized Thermal Transient Impedance, Junction-to-Ambient

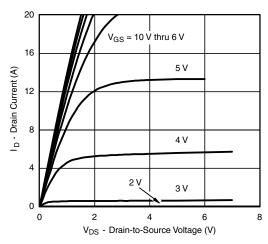


N-CHANNEL TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

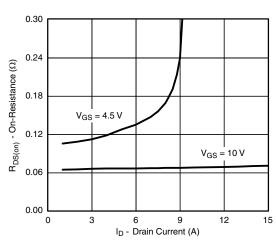


Normalized Thermal Transient Impedance, Junction-to-Foot

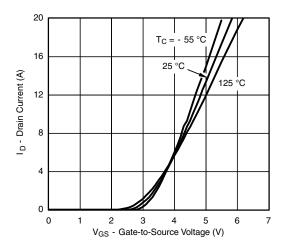
P-CHANNEL TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



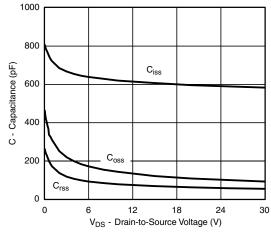
Output Characteristics



On-Resistance vs. Drain Current



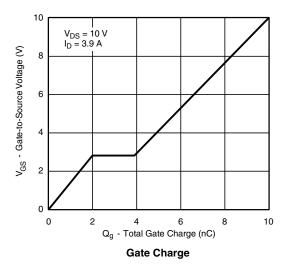
Transfer Characteristics

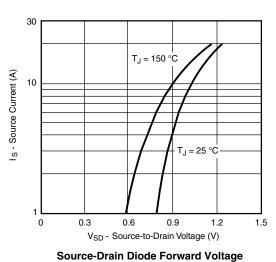


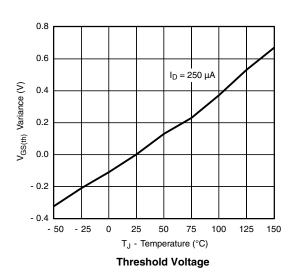
Capacitance

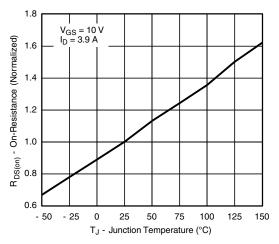
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P-CHANNEL TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

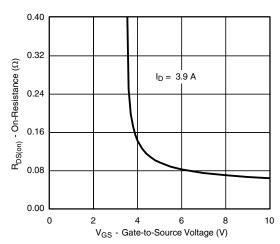




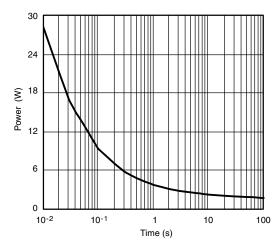




On-Resistance vs. Junction Temperature



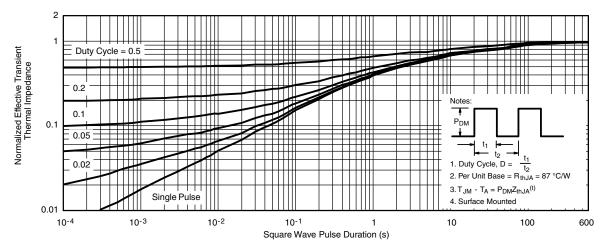
On-Resistance vs. Gate-to-Source Voltage



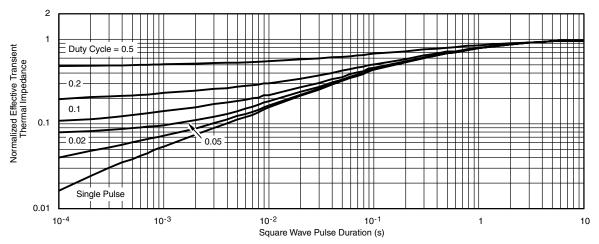
Single Pulse Power, Junction-to-Ambient



P-CHANNEL TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

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Document Number: 71133 S11-1908-Rev. D, 26-Sep-11



SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012







	MILLIM	IETERS	INCHES			
DIM	Min	Max	Min	Max		
Α	1.35	1.75	0.053	0.069		
A ₁	0.10	0.20	0.004	0.008		
В	0.35	0.51	0.014	0.020		
С	0.19	0.25	0.0075	0.010		
D	4.80	5.00	0.189	0.196		
Е	3.80	4.00	0.150	0.157		
е	1.27	BSC	0.050 BSC			
Н	5.80	6.20	0.228	0.244		
h	0.25	0.50	0.010	0.020		
L	0.50	0.93	0.020	0.037		
q	0°	8°	0°	8°		
S	0.44	0.64	0.018	0.026		
ECN: C-06527-Rev. I. 11-Sep-06						

DWG: 5498

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RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)

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